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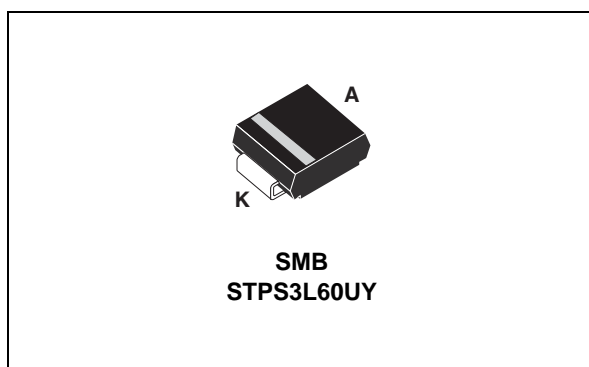
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# STPS3L60U-Y

## Automotive power Schottky rectifier

Datasheet – production data



**Table 1. Device summary**

Symbol	Value
$I_{F(AV)}$	3 A
$V_{RRM}$	60 V
$T_j(max)$	150 °C
$V_F(max)$	0.61 V

### Features

- Negligible switching losses
- Low forward voltage drop
- Avalanche capability specified
- AEC-Q101 qualified

### Description

Surface mount power Schottky rectifier suited for high frequency DC to DC converters. Packaged in SMB, this device is intended for use in low voltage, high frequency inverters and small battery chargers and for applications where there are space constraints.

# 1 Characteristics

**Table 2. Absolute ratings<sup>(1)</sup>**

Symbol	Parameter	Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage	60	V
I <sub>F(RMS)</sub>	RMS forward current	10	A
I <sub>F(AV)</sub>	Average forward current	T <sub>L</sub> = 105 °C δ = 0.5	3
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms Sinusoidal	100
P <sub>ARM</sub>	Repetitive peak avalanche power	t <sub>p</sub> = 1 μs T <sub>j</sub> = 25 °C	2000
T <sub>stg</sub>	Storage temperature range	-65 to + 150	°C
T <sub>j</sub>	Operating junction temperature <sup>(2)</sup> range	-40 to + 150	°C
dV/dt	Critical rate of rise reverse voltage	10000	V/μs

- limiting values, per diode
- $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$  condition to avoid thermal runaway for a diode on its own heatsink

**Table 3. Thermal resistance**

Symbol	Parameter	Value	Unit
R <sub>th(j-l)</sub>	Junction to leads	20	°C/W

**Table 4. Static electrical characteristics**

Symbol	Parameter	Tests Conditions	Min.	Typ.	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	-	-	150	μA
		T <sub>j</sub> = 100 °C	-	4	15	mA
		T <sub>j</sub> = 125 °C	-	14	30	
V <sub>F</sub> <sup>(1)</sup>	Forward voltage drop	T <sub>j</sub> = 25 °C	-	-	0.62	V
		T <sub>j</sub> = 100 °C	-	0.53	0.61	
		T <sub>j</sub> = 125 °C	-	0.51	0.59	
		T <sub>j</sub> = 25 °C	-	-	0.79	
		T <sub>j</sub> = 100 °C	-	0.62	0.71	
		T <sub>j</sub> = 125 °C	-	0.6	0.69	

- Pulse test: t<sub>p</sub> = 380 μs, δ < 2%

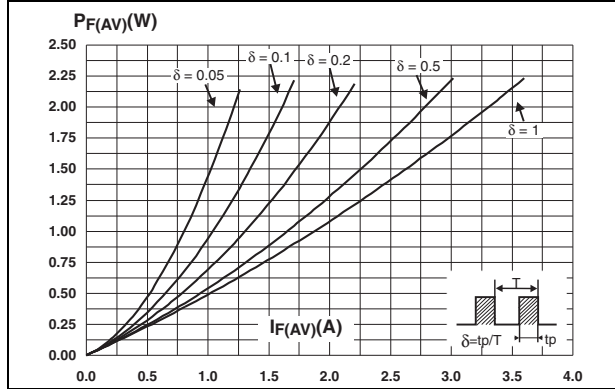
To evaluate the conduction losses use the following equation:

$$P = 0.44 \times I_{F(AV)} + 0.05 \times I_{F(RMS)}^2$$

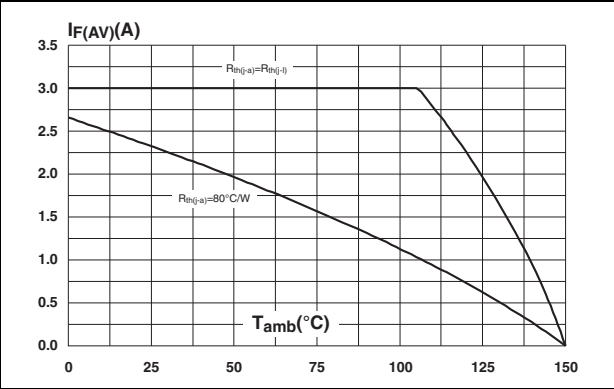
**STPS3L60U-Y**

**Characteristics**

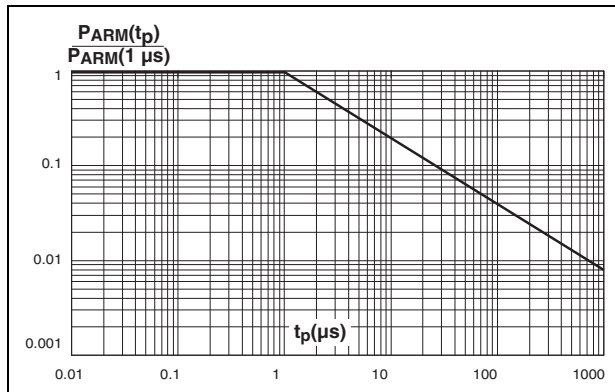
**Figure 1. Average forward power dissipation versus average forward current**



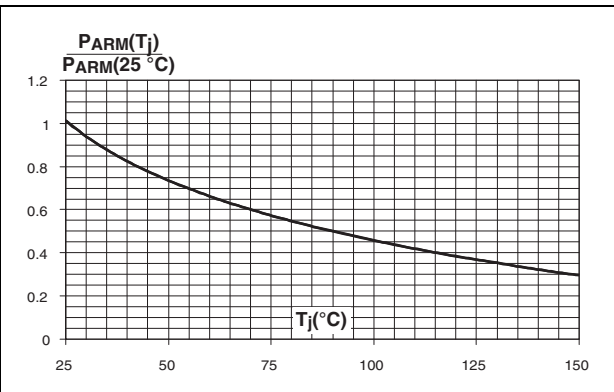
**Figure 2. Average forward current versus ambient temperature ( $\delta = 0.5$ )**



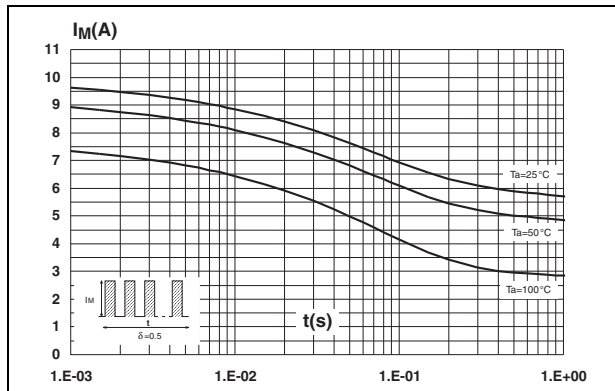
**Figure 3. Normalized avalanche power derating versus pulse duration**



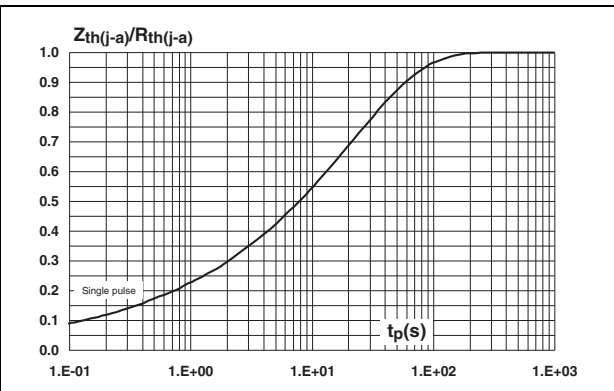
**Figure 4. Normalized avalanche power derating versus junction temperature**



**Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)**



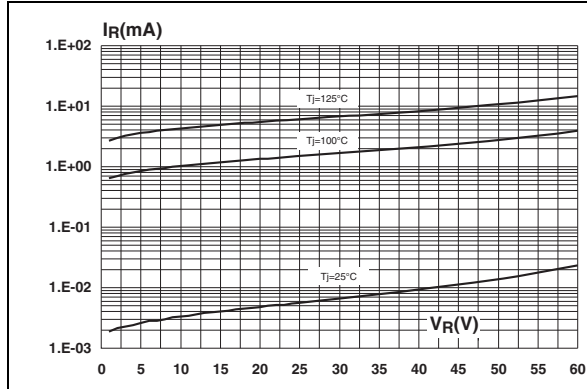
**Figure 6. Relative variation of thermal impedance junction to ambient versus pulse duration**



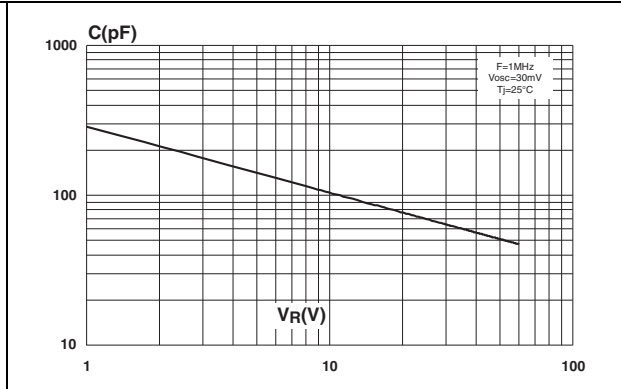
**Characteristics**

**STPS3L60U-Y**

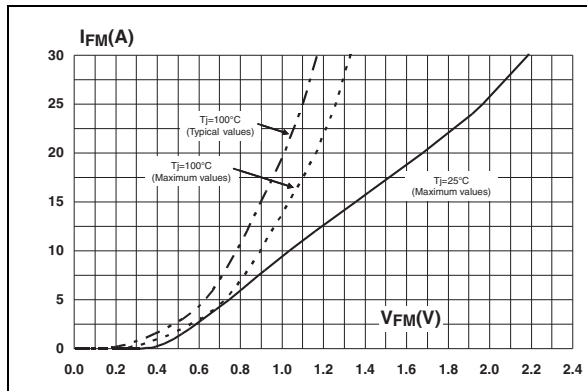
**Figure 7. Reverse leakage current versus reverse voltage applied (typical values)**



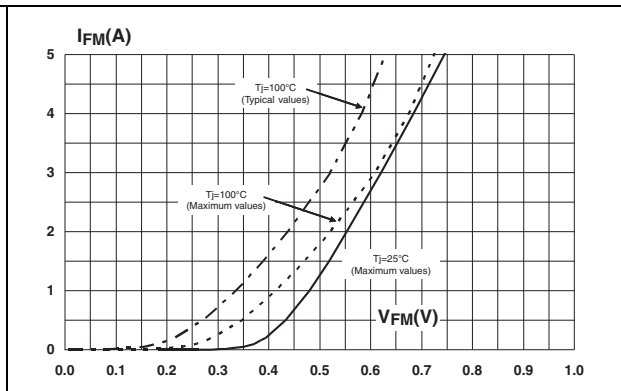
**Figure 8. Junction capacitance versus reverse voltage applied (typical values)**



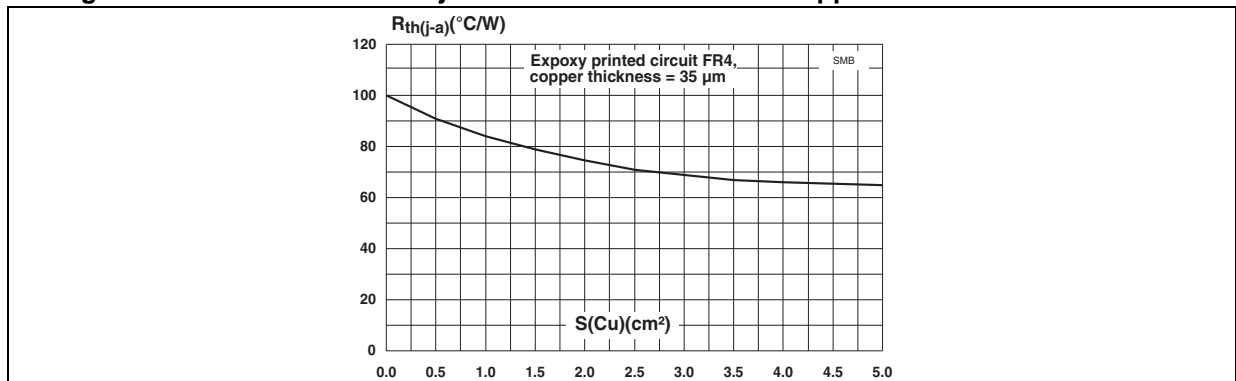
**Figure 9. Forward voltage drop versus forward current (high level)**



**Figure 10. Forward voltage drop versus forward current (low level)**



**Figure 11. Thermal resistance junction to ambient versus copper surface under each lead**



## 2 Package information

- Epoxy meets UL94,V0
- Lead-free package

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Figure 12. SMB dimension definitions

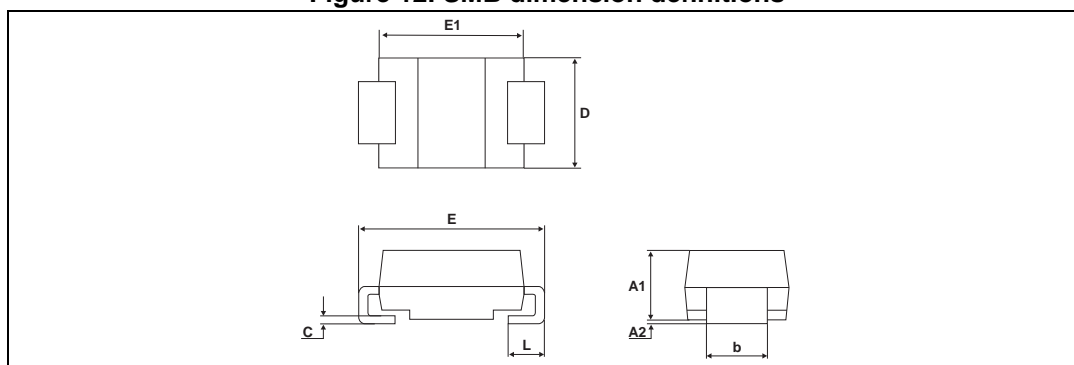
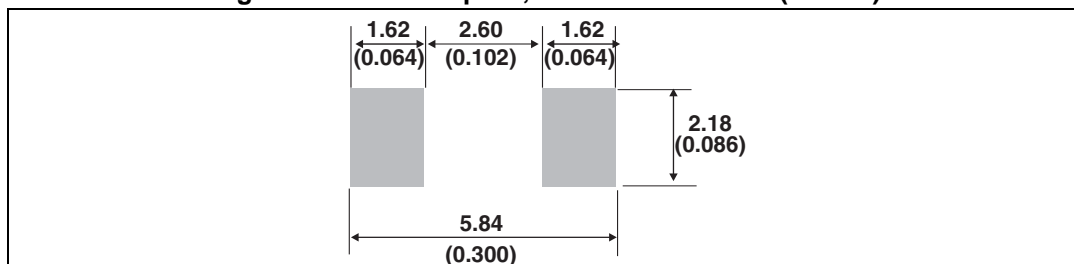


Table 5. SMB dimension values

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
c	0.15	0.40	0.006	0.016
D	3.30	3.95	0.130	0.156
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
L	0.75	1.50	0.030	0.059

Figure 13. SMB footprint, dimensions in mm (inches)



### 3 Ordering information

Table 6. Ordering information

Order codes	Marking	Package	Weight	Base qty	Delivery mode
STPS3L60UY	G36Y	SMB	0.107 g	2500	Tape and reel

### 4 Revision history

Table 7. Document revision history

Date	Revision	Changes
22-Mar-2013	1	Initial release.

## STPS3L60U-Y

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